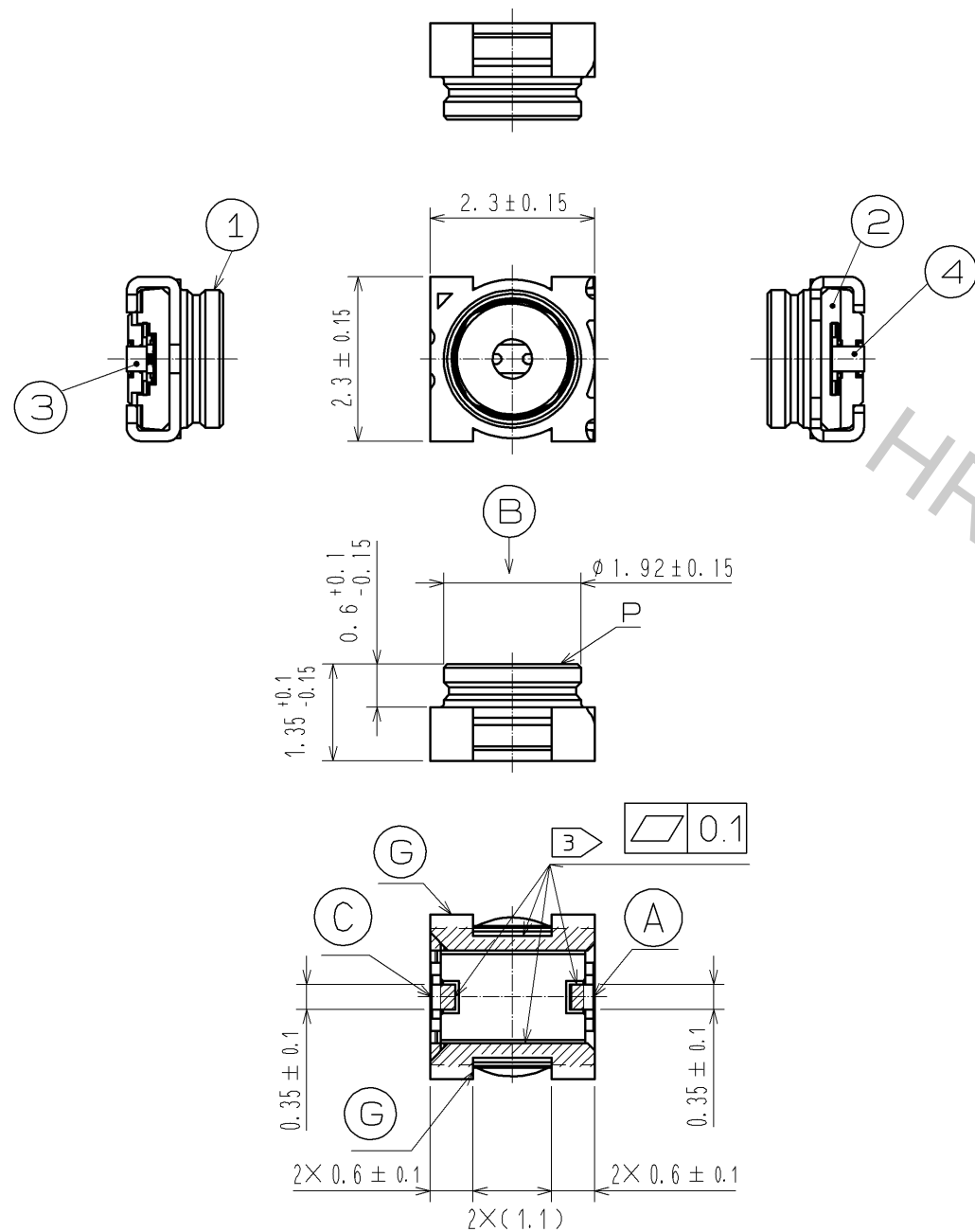
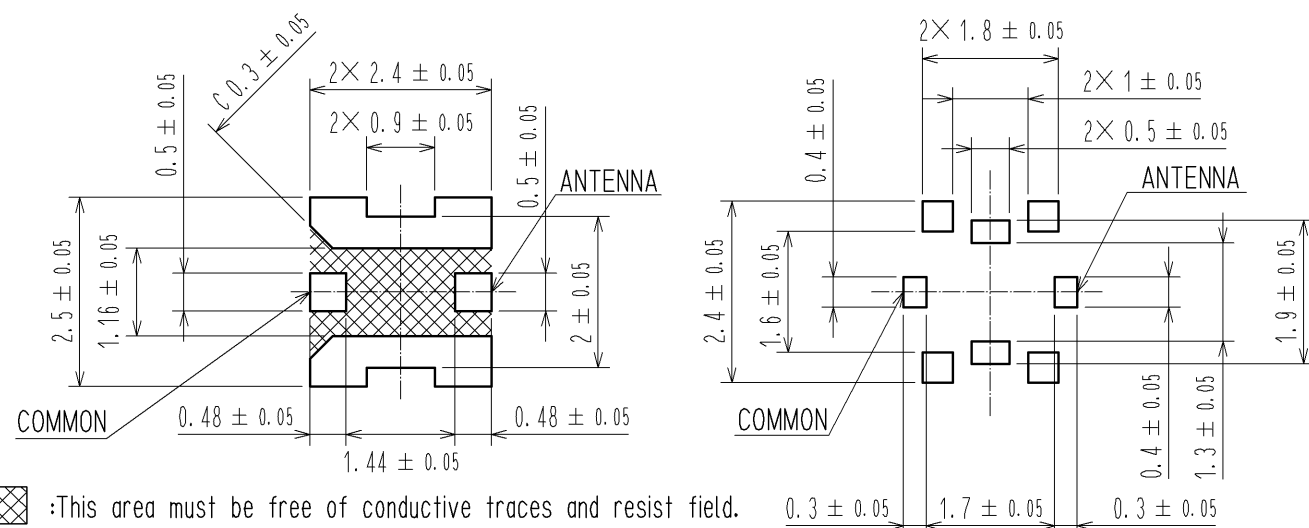




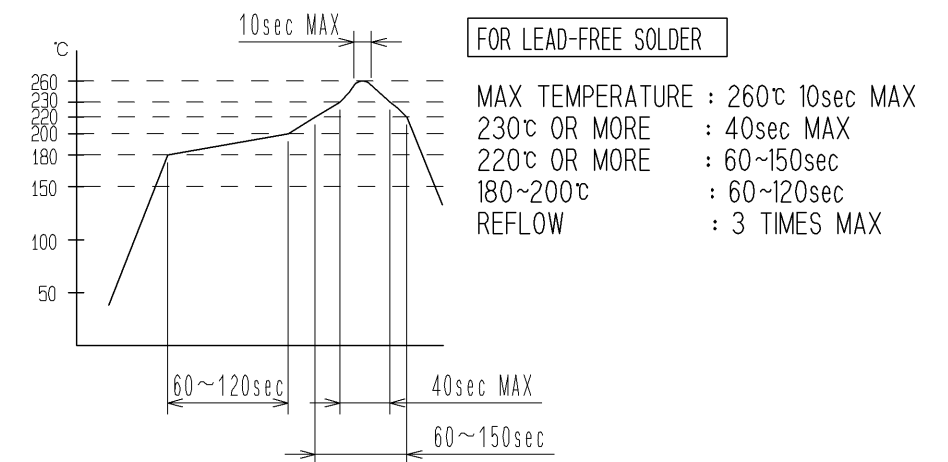
5 SPECIFIED PCB LAYOUT

5 SPECIFIED STENCIL PLATE
THICKNESS: 0.1mm

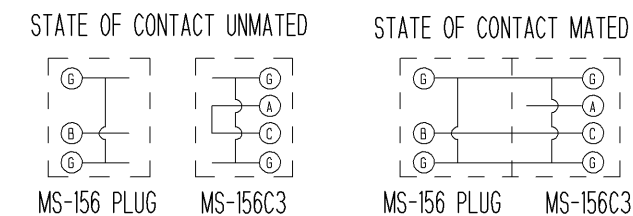


 :This area must be free of conductive traces and resist field.

RECOMMENDED REFLOW TEMPERATURE PROFILE



NOTE 1. Circuit shall be as follows.



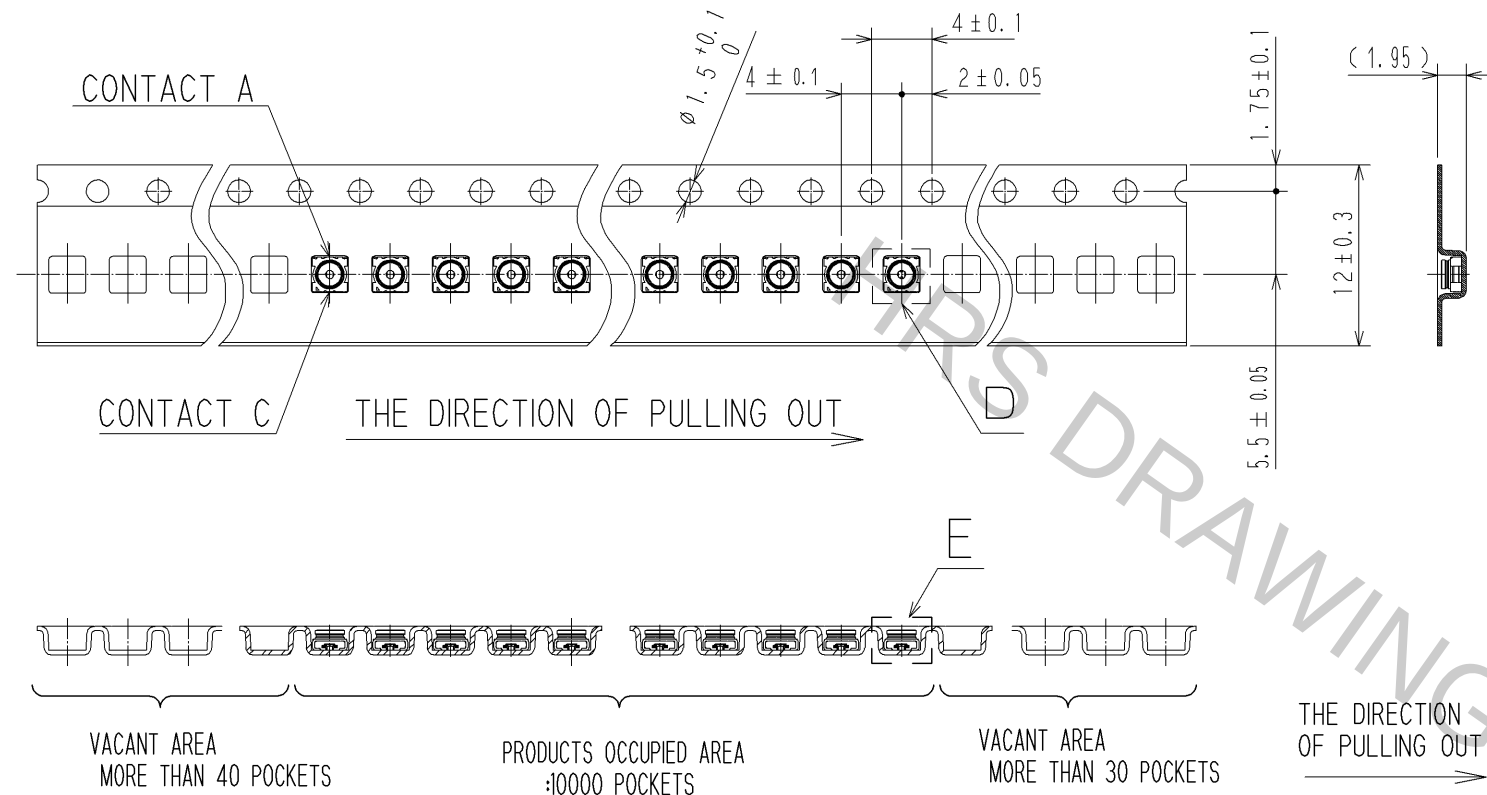
2. For use of this product, be sure to put contact area of plug on position P perpendicularly.
- ③ Lead co-planarity is to be 0.1mm MAX.
4. Do not use the washing process.
- ⑤ Please do not change the specified layout of the PCB dimension and the layout of the stencil plate dimension and thickness otherwise could not be responsible for the solderability of the product.
6. This product is intended to be used for circuit inspection only. Consult us if any other application is considered.
7. Do not use hand soldering for mounting of MS-156C3.

RoHS COMPLIANT

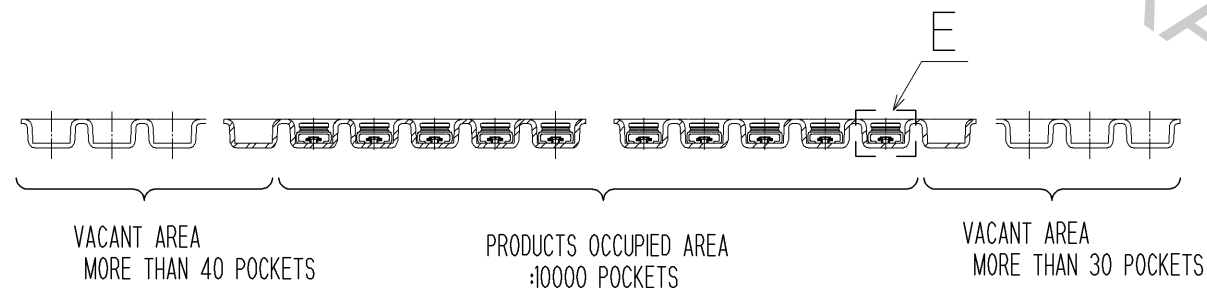
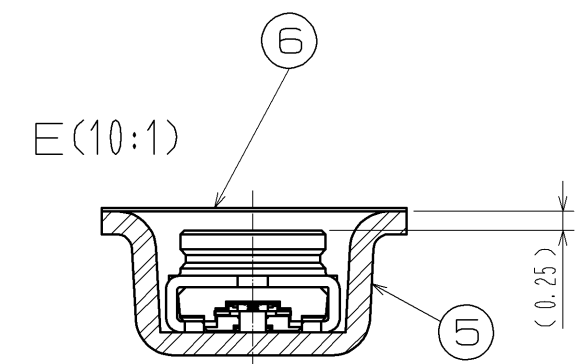
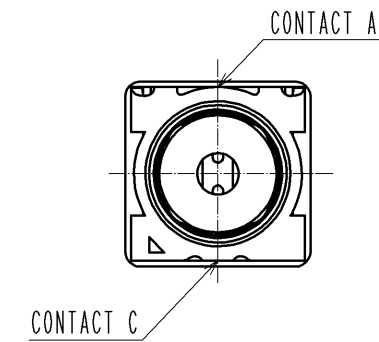
HALOGEN FREE COMPLIANT

3	CU-NI-SI-ALLOY	SELECTIVE GOLD PLATING	6	PET	
2	PA-M		5	PS	
1	PHOSPHOR BRONZE	GOLD PLATING 	4	PHOSPHOR BRONZE	SELECTIVE GOLD PLATING
NO.	MATERIAL	FINISH , REMARKS	NO.	MATERIAL	FINISH , REMARKS

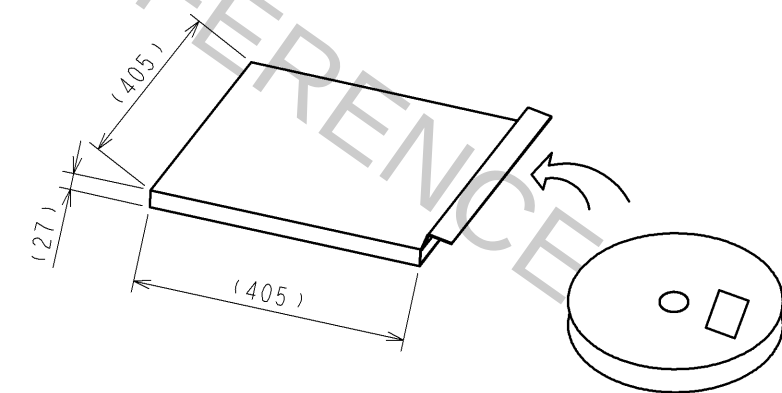
UNITS mm	 	SCALE 10 : 1	 COUNT 1	DESCRIPTION OF REVISIONS DIS-D-003384	DESIGNED DS. YAMAKOSHI	CHECKED NK. NINOMIYA	DATE 14. 09. 02
 HIROSE ELECTRIC CO., LTD.				APPROVED : MH. YAMANE 13. 11. 29 CHECED : NK. NINOMIYA 13. 11. 28 DESIGNED : TS. NAKAGAWA 13. 11. 27 DRAWN : TS. NAKAGAWA 13. 11. 27	DRAWING NO. EDC3-350543-00 PART NO. MS-156C3 CODE NO. CL358-0340-0-00		
							

PACKAGING SPECIFICATION

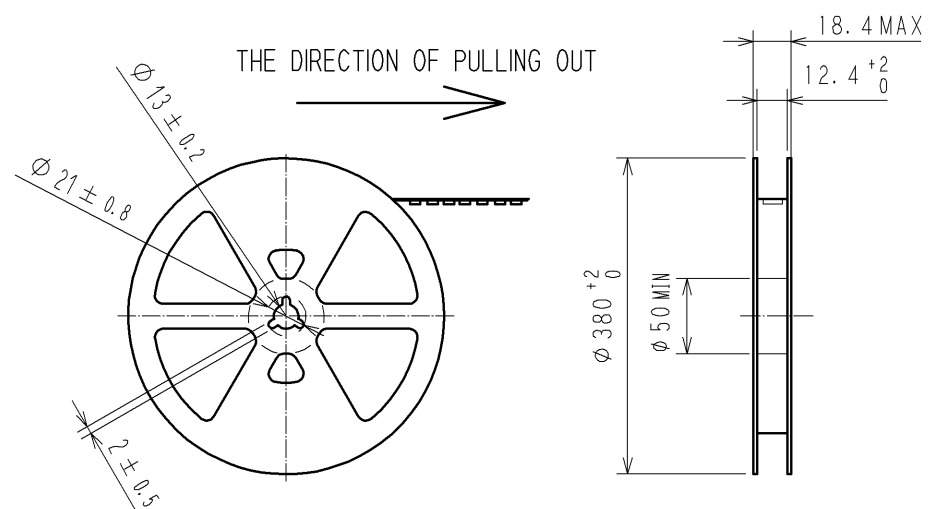
D (10:1)



THE DIRECTION OF PULLING OUT

OUTER PACKAGING CASE(FREE)REEL DIMENSIONS(FREE)

10000 PIECES PER REEL

**HRS**

DRAWING NO.	EDC3-350543-00
PART NO.	MS-156C3
CODE NO.	CL358-0340-0-00

2	2
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